

PATENT ABSTRACTS OF JAPAN

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(71)Applicant : TEIJIN CHEM LTD

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(72)Inventor : FUJII OSAMU
TAKASHIMA HIROBUMI
FUKUMOTO WATARU

(54) RESIN COMPOSITION FOR PRINTING FILM SUPERIOR IN FOLD RESISTANCE AND DECORATING FILM THEREFROM

(57)Abstract:

PROBLEM TO BE SOLVED: This invention provides a resin composition for printing films superior in fold resistance.

SOLUTION: This resin composition for printing film, superior in fold resistance, comprising (A) 40-90 pts.wt. of an aromatic polycarbonate resin and (B) 10-60 pts.wt. of a polyester resin consisting of 0-100 wt.% of a polyethylene terephthalate resin and 0-90 wt.% of a polybutylene terephthalate resin, and the decorating film made therefrom are provided.